

C1812X101JHGACTU

Aliases (C1812X101JHGAC7800) SMD Comm COG HV Flex, Ceramic, 100 pF, 5%, 3,000 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 1812, 2.3 mm



| General Information | |
|--------------------------|-------------------------------------|
| Series | SMD Comm COG HV Flex |
| Style | SMD Chip |
| Description | SMD, MLCC, FT-CAP, Ultra- Stable |
| Features | FT-CAP, Ultra-Stable |
| RoHS | Yes |
| Termination | Flexible Termination |
| Marking | No |
| AEC-Q200 | No |
| Typical Component Weight | 67 mg |
| Shelf Life | 78 Weeks |
| MSL | 1 |

| Dimensions | |
|------------|------------------|
| Chip Size | 1812 |
| L | 4.5mm +/-0.4mm |
| W | 3.2mm +/-0.3mm |
| Т | 1.25mm +/-0.15mm |
| S | 2.3mm MIN |
| В | 0.7mm +/-0.35mm |
| | |

Packaging Specifications

Packaging Packaging Quantity T&R, 180mm, Plastic Tape 1000

| Specifications | |
|--|---------------------------|
| Capacitance | 100 pF |
| Measurement Condition | 1 MHz 1.0Vrms |
| Tolerance | 5% |
| Voltage DC | 3000 VDC |
| Dielectric Withstanding Voltage | 3,600 VDC |
| Temperature Range | -55/+125°C |
| Temp. Coefficient | COG |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 30 ppm/C, 1MegaHz 1.0Vrms |
| Dissipation Factor | 0.1% 1 MHz 1.0Vrms |
| Aging Rate | 0% Loss/Decade Hour |
| Insulation Resistance | 100 GOhms |

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